光信:松下竜谷座乗(休) K & D 加引射性性 し

U'919 L'07\01

MEI Form -2.0, (July, 2006)

Matsushita Ref*: P036508-0	01		Application Serial No			
் <sup>muss be filled)</sup> apan Firm Name: <u>Matsuda Patent Of</u> f		fice		apan Firm Ref:	P36508-01	(P0)
Firm Name: Ratner & Prestia			ı	JS Firm Ref:	MTS-3606U	<u>s</u>
DECLARATIO	ON AND PO	WER OF ATT	ORNEY	FOR U.S. PA	TENT APPLI	CATION
(a) 🔀 Orig		Supplemental				
As a below named in pelow next to my name; and light and joint inventor (if plun sought on the invention entitle	believe that I al inventors a					tizenship are as stated ed below) or an original d for which a patent is
Title of Invention:						
OPTICAL DEVICE, AND PRO	DDUCTION ME	THOD FOR PHOTON	IIC CRYSTA	L SLAB		
which is described and claim	ned in (if the fo	ollowina box is not	checked, t	ne specification (	of which is attact	ned hereto):
Charles described and claim	the lefornise	when submitting this De	claration:prior	o U.S. application filin	g date 2000	在基础的对象。
(f)	cation, or					
· "一个一个一个一个一个一个一个一个一个一个一个一个一个一个一个一个一个一个一个	12) Foru	se when submitting this D	eclarationiafter	U.S. application filing	pale WANTER	esta esta esta esta esta esta esta esta
(g) ☐ the specification in the U.S.		Application No.			filedion?	<b>22</b>
Application:		and with amendments (if applicable):			filedron	,or
3 For PCT US	national éntry under	-35 U.S.C.371 (for use w	hërifilingihis L	eclaration before and	after the U.S. nationals	entry(date)
(h) Sthe specification in the International Application:		PCT Application No.	PCT/JP	2004/18509	(international)	December 10, 2004,
(Check here only for US national entry under	35 U.S.C. 371.)	and with amendr	nents (if ap	plicable):	filedion	
claims, as amended by any a	imendment(s) tuty to disclos	referred to above. e to the U.S. Pate	ent and Tra	demark Office al		ecification, including the
to patentability as defined in	Title 37, Code	of Federal Regula	ations, 91.5	<b>o</b> .		
I hereby claim foreig application(s) for patent or in country other than the United inventor's certificate, or of an	nventor's certi	ficate, or §365(a)	or any PC	i international a d belitteshi oak	elow any foreign	
claimed:						(Foreign Priority Information
COUNTRY AI		PPLICATION NO. DATE OF		FILING	PRIORITY CLAIMED	
Japan	2004-014746			January	22, 2004	Yes
Vapan						

<sup>☐</sup> Additional foreign or international application numbers are listed on a supplemental priority sheet attached hereto.

MEI Form -2.0, (July, 2006)

I hereby claim the benefit under Title 35, United States Code §119(e) of any United States Provisional application(s) listed below. U.S. PROVISIONAL APPLICATION FILING DATE APPLICATION NO. □ Additional U.S. provisional application numbers are listed on a supplemental priority sheet attached hereto. I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s), or §365(C) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application. STATUS: PATENTED, PENDING, ABANDONED U.S. FILING DATE APPLICATION NO. □ Additional U.S. or international application numbers are listed on a supplemental priority sheet attached hereto. POWER OF ATTORNEY: As a named inventor, I hereby appoint the attorneys and agents associated with U.S. Patent and Trademark Office Customer Number identified bellow to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to that customer number. I hereby authorize the U.S. attorneys and agents associated with the customer number to accept and follow instructions from Matsushita Electric Industrial Co., Ltd., and any affiliated or subsidiary company thereof, received via their corporate representatives and/or their foreign patent attorneys or agents, if any, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys or agents and myself. Direct Correspondence to: **CUSTOMER NUMBER** 52473 I further declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon. INVENTOR (s) DATE OF SIGNATURE LAST NAME FIRST NAME Full Name of Sole or First July 14,2006 inventor Hidenobu Hamada CITIZÉNSHIP CITY, STATE or COUNTRY Residence & Citizenship JAPAN Hyogo, JAPAN STATE OR COUNTRY ZIP CODE Post office address **ADDRESS** CITY c/o Matsushita Electric Industrial Co., Ltd. 1006 Oaza Kadoma, Kadoma-shi, Osaka, JAPAN 571-8501 DATE OF SIGNATURE SIGNATURE Full Name of FIRST NAME LAST NAME Second Inventor CITIZENSHIP Residence & Citizenship CITY, STATE or COUNTRY STATE OR COUNTRY ZIP CODE ADDRESS CITY Post office address